



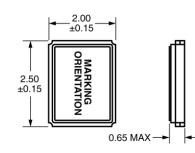
Product Features:

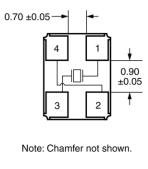
SMD Package Small package Foot Print Supplied in Tape and Reel Compatible with Leadfree Processing Fundamental Mode up to 60MHz Applications: PCMCIA Cards Storage PC's GSM Cell Phone Wireless Lan USB GSM Cell Phone

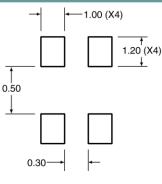
Electrical Specifications

| Frequency | 12MHz to 60MHz |
|--|---|
| Equivalent Series Resistance | |
| 12MHz – 19.999999MHz | 100 Ohms Maximum |
| 20MHz – 29.999999MHz | 80 Ohms Maximum |
| 30MHz – 39.999999MHz | 60 Ohms Maximum |
| 40MHz – 60MHz | 40 Ohms Maximum |
| Shunt Capacitance (C0) | 3.5pF Maximum |
| Frequency Tolerance (at 25°C) | ±50ppm, ±30ppm, ±25ppm, ±20ppm, ±15ppm, or ±10ppm |
| Frequency Stability (over Temperature) | ±50ppm, ±30ppm, ±25ppm, ±20ppm, ±15ppm, or ±10ppm |
| Mode of Operation | Fundamental |
| Crystal Cut | AT Cut |
| Load Capacitance | 8pF to 32pF or Specify |
| Drive Level | 100µW Maximum |
| Aging | ±3ppm/Year Maximum |
| Operating Temperature Range | See Part Number Guide |
| Storage Temperature Range | -40°C to +125°C |

Mechanical and Solder Pad Dimensions









All Dimensions in Millimeters

Part Number Guide

| | | Sample Part Nu | mber: ILCX18 – FB1F18 – | - 20.000 MHz | | |
|-----------------------------|------------------------|------------------------|---|-----------------------|---------------------------|--------------|
| Package | Frequency Tolerance | Frequency Stability | Operating Temperature Range | Mode of Operations | Load Capacitance | Frequency |
| | $B = \pm 50 ppm$ | $B = \pm 50 ppm$ | $0 = 0^{\circ}C \text{ to } +50^{\circ}C$ | | 8pF to 32pF or Specify | - 20.000 MHz |
| | $F = \pm 30 ppm$ | $F = \pm 30 ppm$ | $1 = 0^{\circ}C \text{ to } +70^{\circ}C$ | - | | |
| H = ±20 ILCX18 - I = ±15 | $G = \pm 25 ppm$ | $G = \pm 25 ppm$ | 2 = -10°C to +60°C | | | |
| | $H = \pm 20 ppm$ | $H = \pm 20 ppm$ | 3 = -20°C to +70°C | | | |
| | $I = \pm 15 ppm$ | I = ±15ppm** | $5 = -40^{\circ}$ C to $+85^{\circ}$ C* | F = Fundamental | | |
| | $J = \pm 10$ ppm | J = ±10ppm** | 8 = -30°C to +85°C* | | | |
| | | | 9 = -10°C to +50°C | - | | |
| | | | D = -10°C to +105°C* | | | |
| | | | E = -40°C to +105°C* | | | |

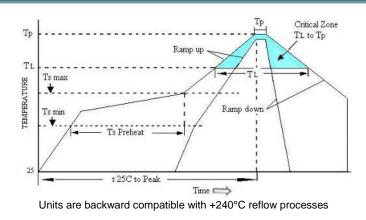
* Not available at all frequencies. * Not available for all frequency stability options.

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Pb Free Solder Reflow Profile:

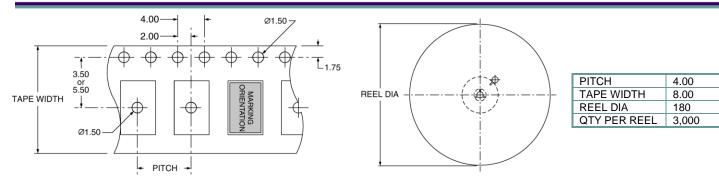


| Package | Information: |
|----------|--------------|
| I acraye | mormation. |

MSL = 1

Termination = e4 (Au over Ni over W base metallization)

Tape and Reel Information:



Environmental Specifications:

| Thermal Shock | MIL-STD-883, Method 1011, Condition A | |
|------------------------------|---|--|
| Moisture Resistance | MIL-STD-883, Method 1004 | |
| Mechanical Shock | MIL-STD-883, Method 2002, Condition B | |
| Mechanical Vibration | MIL-STD-883, Method 2007, Condition A | |
| Resistance to Soldering Heat | J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max) | |
| Hazardous Substance | Pb-Free / RoHS / Green Compliant | |
| Solderability | JESD22-B102-D Method 2 (Preconditioning E) | |
| Terminal Strength | MIL-STD-883, Method 2004, Test Condition D | |
| Gross Leak | MIL-STD-883, Method 1014, Condition C | |
| Fine Leak | MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s | |
| Solvent Resistance | MIL-STD-202, Method 215 | |

Marking:

Line 1: I-Date Code (Date Code = YWW) Line 2: Frequency

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| Ts max to T _L (Ramp-up Rate) | 3ºC / second max | |
|---|-------------------|--|
| Preheat | | |
| Temperature min (Ts min) | 150°C | |
| Temperature typ (Ts typ) | 175ºC | |
| Temperature max (Ts max) | 200°C | |
| Time (Ts) | 60 to180 seconds | |
| Ramp-up Tate (T _L to Tp | 3ºC / second max | |
| Time Maintained Above | | |
| Temperature (T _L) | 217ºC | |
| Time (T _{L)} | 60 to 150 seconds | |
| Deals Terra eneture (Te) | 260°C max for 10 | |
| Peak Temperature (Tp) | seconds | |
| Time within 5°C to Peak | 20 to 40 seconds | |
| Temperature (Tp) | 2010403600105 | |
| Ramp-down Rate | 6°C / second max | |
| Tune 25°C to Peak Temperature | 8 minutes max | |